

GaAs PIN Reflective SP6T Switch Chip, 10-40GHz

Performance characteristics

- Frequency Range: 10-40GHz
- Insertion loss : 1.3dB typ.
- Isolation: 53 dB typ.
- P-1dB: 26dBm @17GHz
- 50Ohm input / output
- 100% on-wafer testing
- Chip size: 2.12 x 1.52 x 0.1mm
- Silicon nitride passivation, scratch protection

Product Introduction

GSW6B2 is a GaAs PIN reflective single-pole six-throw switch chip with 50Ω matching at the input/output end, a frequency range of 10 to 40GHz, and -5/+5V control. It has a built-in bias network and DC blocking capacitors, which is easy to use. It has excellent switching characteristics and port standing wave characteristics in the entire operating frequency range, and is very suitable for microwave hybrid integrated circuits, multi-chip modules, and low-power systems. The switch chip uses on-chip through-hole metallization technology to ensure good grounding, does not require additional grounding measures, and is simple and convenient to use. The back of the chip is metallized, which is suitable for eutectic sintering or conductive adhesive bonding processes.

Use restriction parameter ¹	
Maximum input voltage	2.5V
Maximum input power	+30dBm CW
Operating temperature	-55 ~ +85°C
storage temperature	-65 ~ +150°C

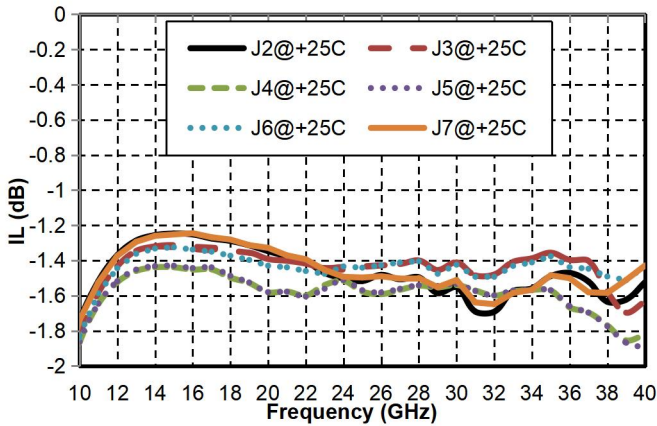
【1】 Exceeding any of these maximum limits may cause permanent damage.

Electrical performance parameters (TA = +25°C)				
index	Minimum	Typical Value	Maximum	unit
Frequency Range	10-40			G Hz
Insertion loss	-	1.5	1.7	dB
Isolation	36	47	-	dB
Input return loss	11	16	-	dB
Output return loss	11	15	-	dB
P-1dB @17GHz	-	26	-	dBm
Switching speed	-	30	-	ns

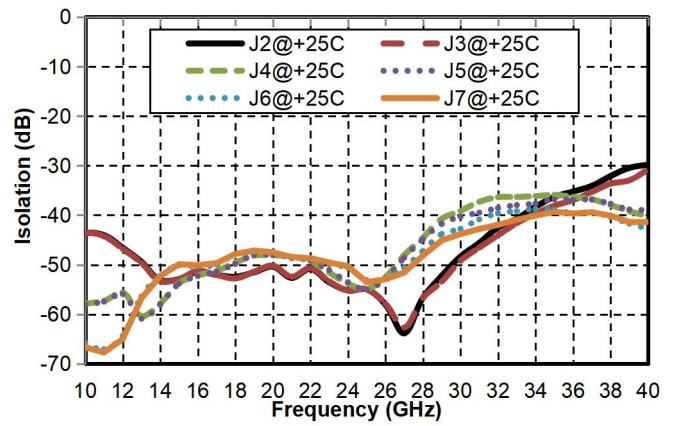
GaAs PIN Reflective SP6T Switch Chip, 10-40GHz

Main index test curve

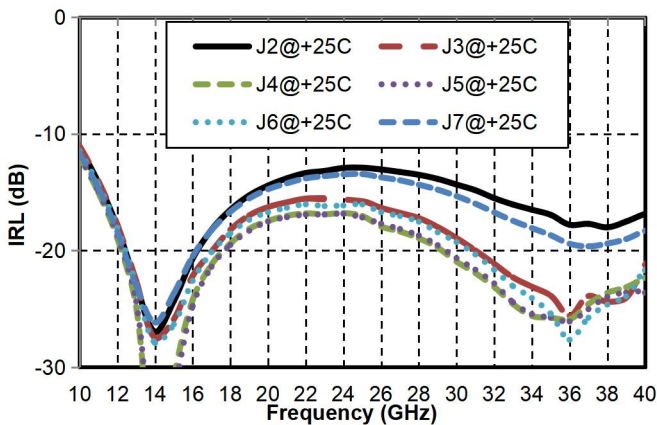
Insertion Loss vs. Operating Frequency



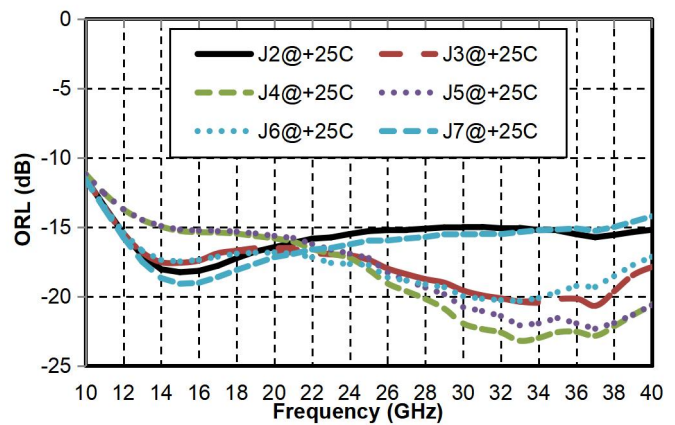
Isolation vs. Operating Frequency



Input Return Loss vs. Frequency



Output Return Loss vs. Frequency



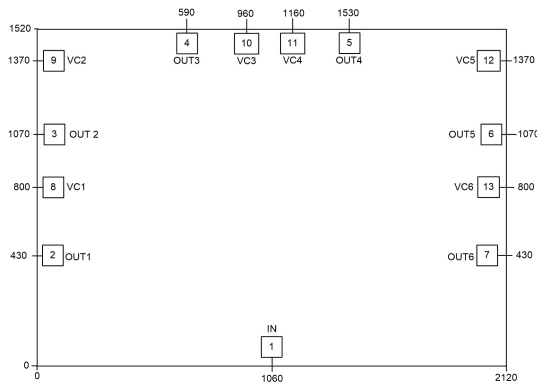
Typical Driver Connections

Control port (mA)						Output conduction condition					
VC1	VC2	VC3	VC4	VC5	VC6	J2-J1	J3-J1	J4-J1	J5-J1	J6-J1	J7-J1
-10	+20	+20	+20	+20	+20	Continuity	isolation	isolation	isolation	isolation	isolation
+20	-10	+20	+20	+20	+20	isolation	Continuity	isolation	isolation	isolation	isolation
+20	+20	-10	+20	+20	+20	isolation	isolation	Continuity	isolation	isolation	isolation
+20	+20	+20	-10	+20	+20	isolation	isolation	isolation	Continuity	isolation	isolation
+20	+20	+20	+20	-10	+20	isolation	isolation	isolation	isolation	Continuity	isolation
+20	+20	+20	+20	+20	-10	isolation	isolation	isolation	isolation	isolation	Continuity

Note: V = +1.35 V, I = +20mA; V = -3.2V, I = -10mA (including J1 on-chip resistor RIN = 50 ohm voltage divider)

GaAs PIN Reflective SP6T Switch Chip, 10-40GHz

Appearance structure

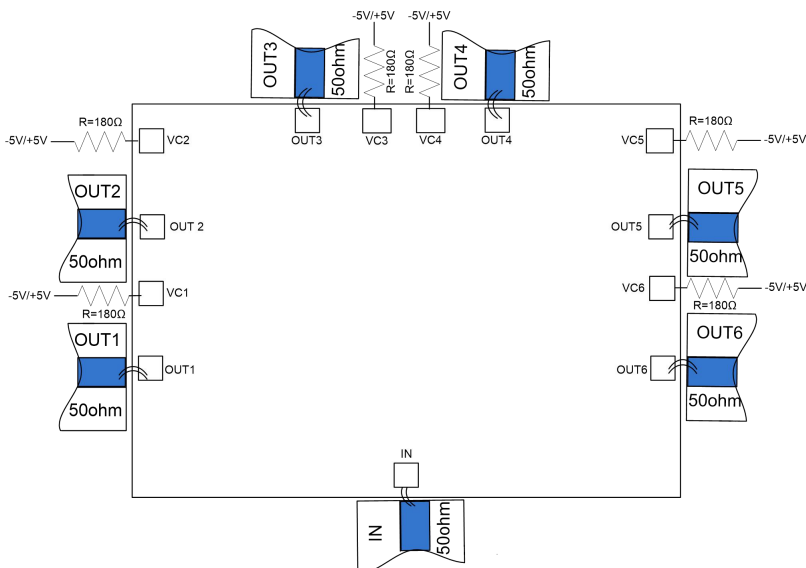


All units in the figure are micrometers

Bonding point definition

Bonding point number	Function Symbol	Functional Description
1	IN(J1)	RF input signal terminal
2, 3, 4, 5, 6, 7	OUT1(J2), OUT2(J3), OUT3(J4), OUT4(J5) OUT5(J6), OUT6(J7)	RF output signal terminal
8, 9, 10, 11, 12, 13	VC1, VC2, VC3, VC4, VC5, VC6	Control Port
Chip bottom	GND	The bottom of the chip needs to be well grounded to RF and DC

Recommended circuit diagram



+5V is connected in series with R=180 ohm resistor , V =+ 1.35V , I=+20mA . -5V is connected in series with R=180 ohm resistor , V=-3.2V, I=-10mA .

Note: If you need to reduce power consumption, you need to connect +5V /-5V in series with resistors of different resistance values. For example: +5V in series with R=370 ohm resistor : $V=+1.3V$, $I=+10mA$; -5V in series with R=180 ohm resistor $V=-3.2V$, $I=-10mA$. (Including the internal resistor $R_{IN}=50$ ohm voltage divider at J1 end). Please contact the manufacturer for specific usage.